



Electrochemical Deposition and Characterization of Thin Films

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Deadline for manuscript submissions:

closed (20 November 2023)

Message from the Guest Editors

Dear Colleagues,

The past decades have seen intensive improvement in thin film deposition methods. Today, it is possible to coat surfaces with complex compositions and synthesize multilayers, enabling the development of synergistic effects through the mutual interaction of such layers. The deposition of complex structures allows for the development of new technologies, with recent advances in deposition techniques further miniaturizing electronic devices.

The development of these new technologies toward scaling down the size of the produced devices requires accurate control of the deposition process. The latter then allows tailoring thin films and nanodevices to one's desire. Recent advances are not only limited to nanoelectronics but are applicable to every field, viz., anti-corrosion coating, biocidal coating, or photovoltaic devices, in order to cope with the present demands of society.

This Special Issue invites researchers studying subjects related to electrochemical deposition, film characterization using various methods, as well as any other related subjects to submit full research papers, short communications, and review articles.

Guest Editors





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Message from the Editor-in-Chief

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